

Description

The ZXTR2108F monolithically integrates a transistor, zener diode and resistor to function as a linear regulator. The device regulates with an 8V nominal output at 15mA. It is designed for use in high voltage applications where standard linear regulators cannot be used. This function is fully integrated into a SOT23 package, minimizing PCB area and reducing the number of components when compared with a multi-chip discrete solution.

Applications

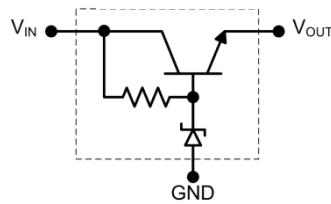
Supply voltage regulation for:

- 24V to 8V Rails
- Other Customized Input Rails

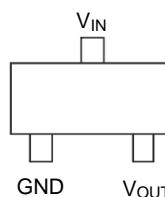
SOT23



Top View



Internal Device Schematic



Top View
Pin-Out

Pin Name	Pin Function
V _{IN}	Input Supply
GND	Power Ground
V _{OUT}	Voltage Output

Ordering Information (Note 4)

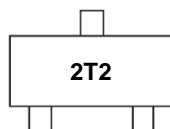
Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTR2108F-7	AEC-Q101	2T2	7	8	3,000

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

SOT23



2T2 = Product Type Marking Code

Absolute Maximum Ratings (Voltage relative to GND, @ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Voltage	V_{IN}	-0.3 to 60	V
Continuous Input & Output Current	I_{IN}, I_{OUT}	320	mA
Peak Pulsed Input & Output Current	I_{IM}, I_{OM}	2	A
Maximum Voltage applied to V_{OUT}	$V_{OUT(max)}$	Smaller of $V_{IN}+5\text{V}$ or 13V	V

Maximum Current at $V_{IN} = 24\text{V}$ (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Continuous Output Current	I_{OUT}	40	mA
Pulsed Output Current	I_{OM}	2,000	mA
		375	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation	P_D	625	mW
		500	
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	°C/W
		250	
Thermal Resistance, Junction to Lead	$R_{\theta JL}$	197	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	17	
Maximum Operating Junction and Storage Temperature Range	T_J, T_{STG}	-65 to +150	°C

ESD Ratings (Note 11)

Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	C

Notes: 5. For a device mounted with the V_{IN} lead on 25mm x 25mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.

6. Same as note 5, except mounted on 15mm x 15mm 1oz copper.

7. Same as note 5, whilst operating at $V_{IN}=24\text{V}$. Refer to Safe Operating Area for other Input Voltages.

8. Same as note 5, except measured with a single pulse width = 100 μs and $V_{IN}=24\text{V}$.

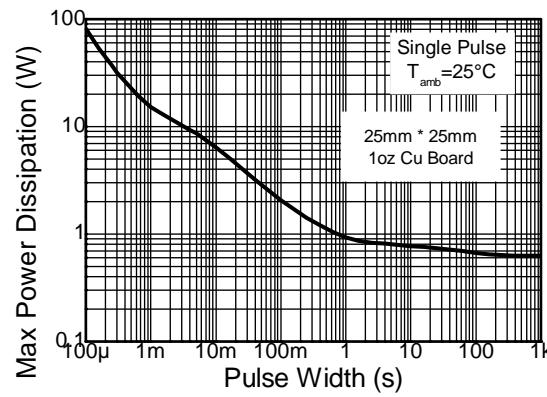
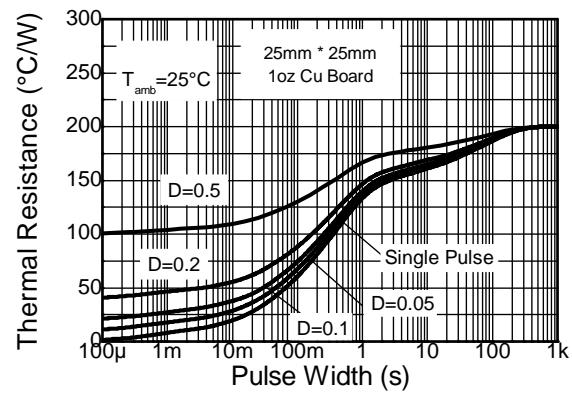
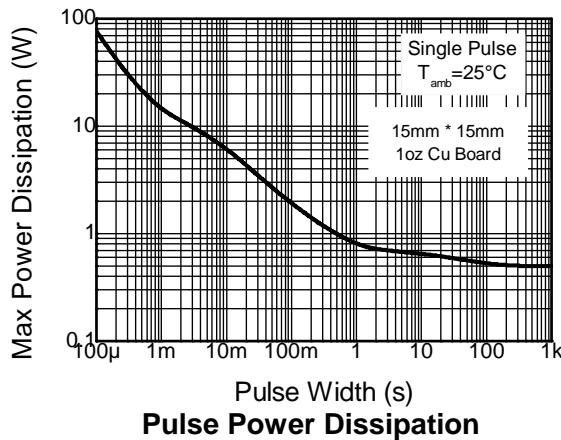
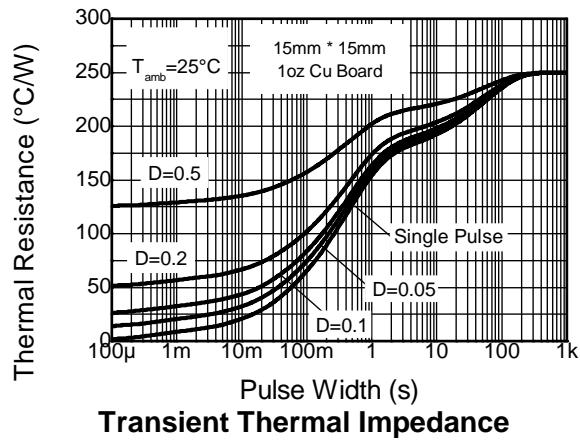
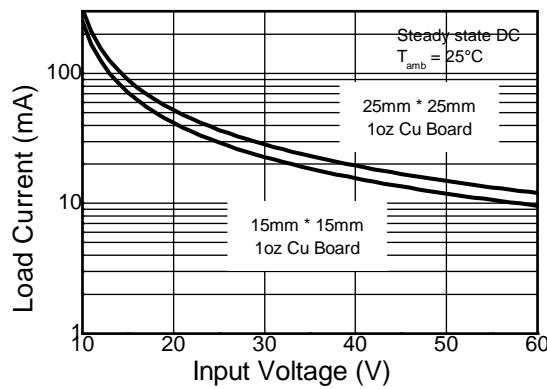
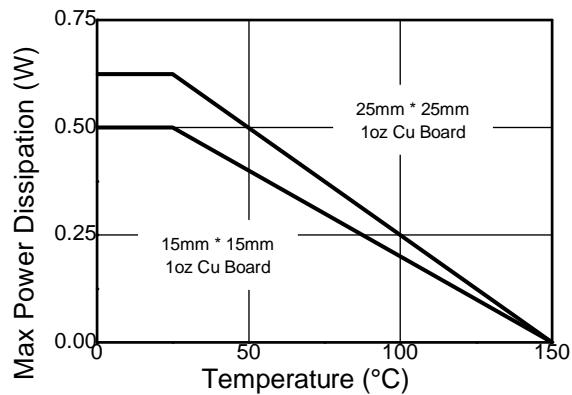
9. Same as note 5, except measured with a single pulse width = 10ms and $V_{IN}=24\text{V}$.

10. $R_{\theta JL}$ = Thermal resistance from junction to solder-point (at the end of the V_{IN} lead).

$R_{\theta JC}$ = Thermal resistance from junction to the top of case.

11. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

Thermal Characteristics and Derating Information



Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Output Voltage (Note 12)	V_{OUT}	7.2	8	8.8	V	$V_{IN} = 24\text{V}$, $I_{OUT} = 15\text{mA}$
Line Regulation (Notes 12 & 13)	ΔV_{OUT}	—	15	50	mV	$V_{IN} = 18$ to 24V , $I_{OUT} = 15\text{mA}$
		—	110	—		$V_{IN} = 12$ to 60V , $I_{OUT} = 15\text{mA}$
		—	120	—		$V_{IN} = 10$ to 60V , $I_{OUT} = 15\text{mA}$
Temperature Coefficient	$\Delta V_{OUT}/\Delta T$	—	7.2	—	$\text{mV}/^\circ\text{C}$	$T_J = -40^\circ\text{C}$ to $+125^\circ\text{C}$ $V_{IN} = 24\text{V}$, $I_{OUT} = 15\text{mA}$
Load Regulation (Notes 12 & 14)	ΔV_{OUT}	—	-16 -150	-50 -300	mV	$I_{OUT} = 10$ to 20mA , $V_{IN} = 24\text{V}$ $I_{OUT} = 0.1$ to 50mA , $V_{IN} = 24\text{V}$
Minimum Value of Input Voltage Required to Maintain Line Regulation	$V_{IN(\text{MIN})}$	10	—	—	V	—
Quiescent Current	I_Q	—	260 3,700	500 6,000	μA	$V_{IN} = 12\text{V}$, $I_{OUT} = 10\mu\text{A}$ $V_{IN} = 60\text{V}$, $I_{OUT} = 10\mu\text{A}$
Power Supply Rejection Ratio	$\Delta V_{in}/\Delta V_{out}$	—	45	—	dB	$C_{OUT} = 100\text{nF}$, $I_{OUT} = 15\text{mA}$, $V_{OUT} = 8\text{V}$, $V_{IN} = 10$ to 60V , $f = 100\text{Hz}$

Notes: 12. Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$.

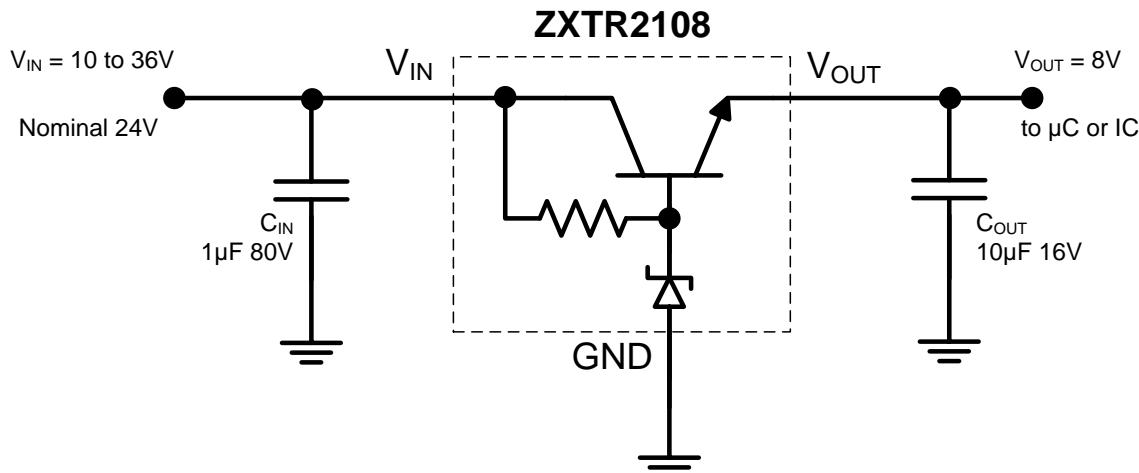
13. Line regulation $\Delta V_{OUT} = V_{OUT}(@V_{IN}=24\text{V}) - V_{OUT}(@V_{IN}=18\text{V})$

$\Delta V_{OUT} = V_{OUT}(@V_{IN}=60\text{V}) - V_{OUT}(@V_{IN}=10\text{V})$

$\Delta V_{OUT} = V_{OUT}(@V_{IN}=60\text{V}) - V_{OUT}(@V_{IN}=12\text{V})$

14. Load regulation $\Delta V_{OUT} = V_{OUT}(@I_{OUT}=20\text{mA}) - V_{OUT}(@I_{OUT}=10\text{mA})$

$\Delta V_{OUT} = V_{OUT}(@I_{OUT}=50\text{mA}) - V_{OUT}(@I_{OUT}=0.1\text{mA})$

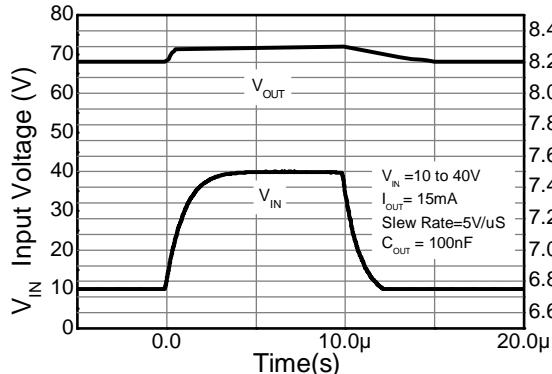
Typical Application Circuit


Example of a 8V regulated supply from a nominal 24V for powering a Controller IC.

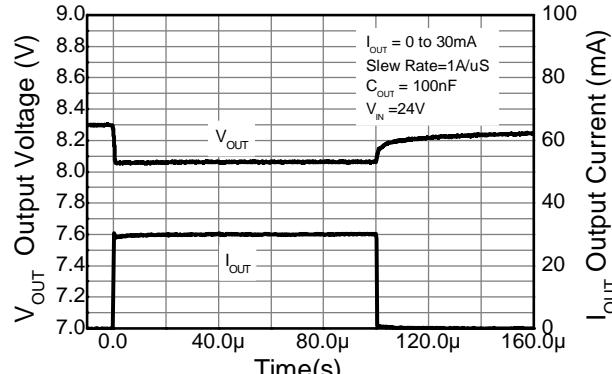
Pin Function

Pin Name	Pin Function	Notes
V_{IN}	Input Supply	Input voltage can vary from -0.3V to 60V with respect to GND; for V_{OUT} regulated then $10\text{V} \leq V_{IN} \leq 60\text{V}$. It is recommended to connect a $1\mu\text{F}$ capacitor to GND.
GND	Power Ground	This pin should be tied to the system ground.
V_{OUT}	Voltage Output	Outputs a regulated 8V when $10\text{V} \leq V_{IN} \leq 60\text{V}$. When $V_{IN} < 10\text{V}$, then V_{OUT} maximum = $V_{IN} - 1\text{V}$. The pin can be pulled high to a maximum of $+13\text{V}$ with respect to GND, or $+5\text{V}$ with respect to V_{IN} , whichever is lower. It is recommended to connect a $10\mu\text{F}$ capacitor to GND and a minimum of $10\mu\text{A}$ to be drawn from V_{OUT} to maintain regulation.

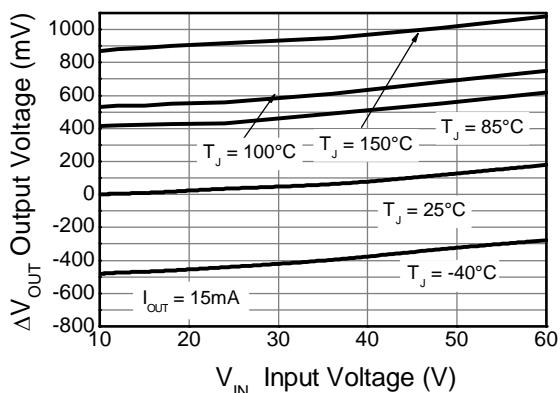
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



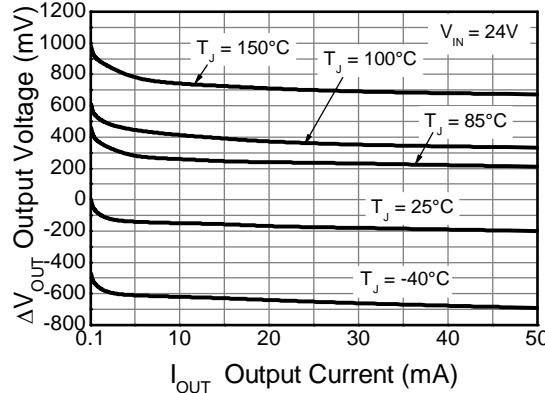
Line transient response



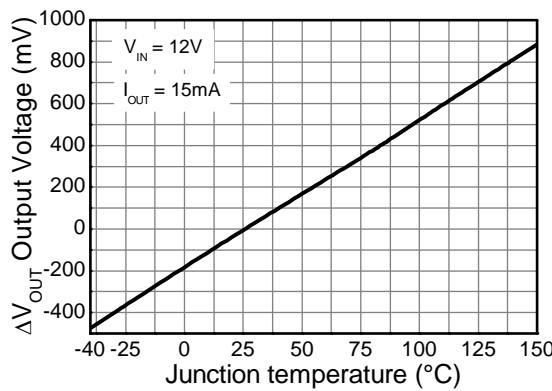
Load transient response



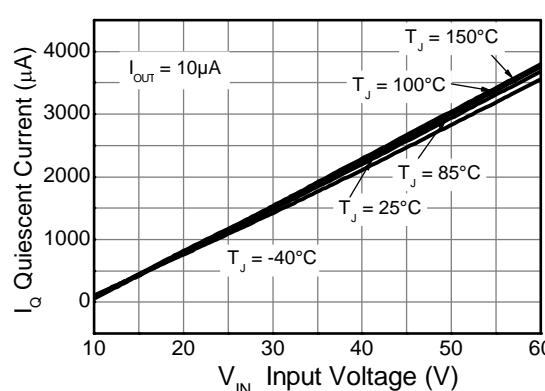
Line Regulation (Note 15)



Load Regulation (Note 16)



Temperature Coefficient (Note 17)



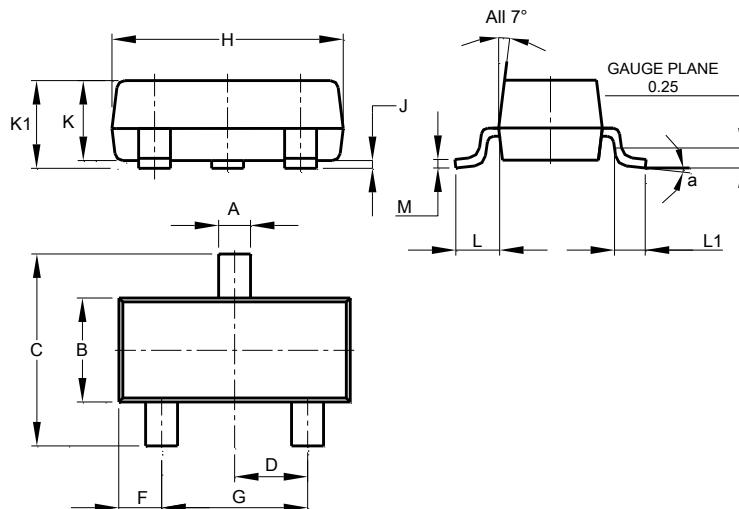
Quiescent Current

Notes:

15. Line Regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT}$ (@ $V_{IN} = 10\text{V}$, $I_{OUT} = 15\text{mA}$, $T_J = +25^\circ\text{C}$).
16. Load Regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT}$ (@ $V_{IN} = 24\text{V}$, $I_{OUT} = 0.1\text{mA}$, $T_J = +25^\circ\text{C}$).
17. Temperature Coefficient $\Delta V_{OUT} = V_{OUT} - V_{OUT}$ (@ $V_{IN} = 24\text{V}$, $I_{OUT} = 15\text{mA}$, $T_J = +25^\circ\text{C}$).

Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

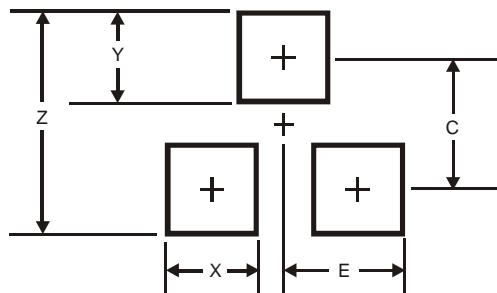


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	8°		

All Dimensions in mm

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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